

# ET-5050H-3F1W Neutral White

Ultra high luminous efficacy, combined with the flexibility in design due to its slim and miniature size, PLCC LED Series are optimized to be used as lighting for building.

#### **Features**

- High luminous Intensity and high efficiency
- Based on InGaN / GaN technology
- Wide viewing angle : 120°
- Excellent performance and visibility
- Suitable for all SMT assembly methods
- IR reflow process compatible
- Environmental friendly; RoHS compliance
- High color rendering index

#### **Typical Applications**

- Signal and Symbol Luminaire
- Indoor and Outdoor Displays
- Backlighting (illuminated advertising, general lighting)
- Interior Automotive Lighting



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#### Product Nomenclature

The following table describes the available color, package size, and chip quantity.

	E	: 1	[ - 5	505	<u>50 H</u> -	- 3	<u>F</u>	<u>1 W</u>	ı	
		X1		X2	X3	Х	4 X5	X6 X7	7	
X1 LED It			X2 age Type		X3 Ing Color		(4 Juantity	X5~X6 Serial No.	F	X7 eature
Code	Type	Code	Туре	Code	Type	Code	Type		Code	Туре
Edison To	p LED	3528	3.5×2.8mm	w	Cool White	1	1pcs		W	White surface
		5050	5.0×5.0mm	н	Neutral White	3	3pcs		В	Black surface
				х	Warm White	А	0.5W		D	Black housing
				R	Red	В	1W			
				А	Amber (590nm)					
				т	True Green					
				В	Blue					
				RTB	RGB 3 chips					

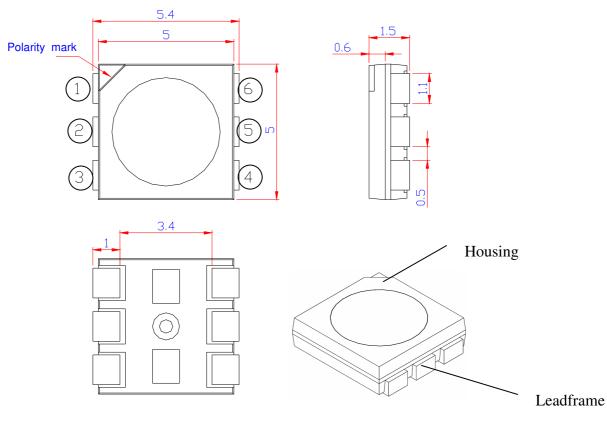
< Table 1 PLCC 5050 series Nomenclature >

#### **Environmental Compliance**

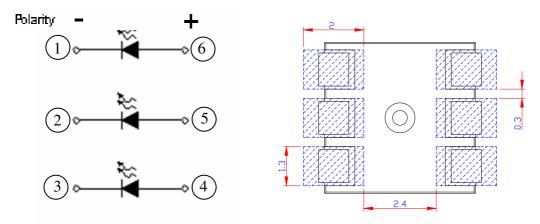
PLCC 5050 series are compliant to the Restriction of Hazardous Substances Directive or RoHS. The restricted materials including lead, mercury cadmium hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ether (PBDE) are not used in PLCC 5050 series to provide an environmentally friendly product to the customers.



#### LED Package Dimensions and Polarity



< Figure 1 PLCC 5050 series dimensions >



< Figure 2 PLCC 5050 series circuit diagram and recommended soldering pad >

#### Notes:

- 1. All dimensions are in mm.
- 2. Tolerance : ± 0.2 mm



### Absolute Maximum Ratings

#### The following table describes absolute maximum ratings of PLCC 5050 series.

< Table 2 Absolute maxin	num ratings	for PLCC	5050 series>
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Parameter	Rating	Unit	Symbol
Forward Current	30	mA	I <sub>F</sub>
Pulse Forward Current	100	mA	
(tp $\leq$ 100µs, Duty cycle=0.25)	100	ШA	
Reverse Voltage	5	V	$V_{R}$
Forward Voltage	3.8	V	$V_F$
Power Dissipation	115	mW	
LED Junction Temperature	125	°C	$T_J$
Operating Temperature	-30 ~ +85	°C	
Storage Temperature	-40 ~ +100	°C	
Soldering Temperature	255~260	°C	
Manual Soldering at $350^{\circ}C$ (Max.)	3	Sec	

Notes:

- 1. Above values are based on 1-chip performance.
- 2. Proper current derating must be observed to maintain junction temperature below the maximum at all time.
- 3. LEDs are not designed to be driven in reverse bias.
- 4. tp: Pulse width time



#### Luminous Intensity Characteristics

#### The following table describes luminous intensity of PLCC 5050 series.

< Table 3 Luminous intensity characteristics at I\_F=20mA and Ta=25 $^\circ\!\!\mathbb{C}$  for PLCC 5050 series >

Part Name	Color	Lun	ninous inte	nsity	Luminous Flux
	00101	Min.	Тур.	Max.	Typ.(Im)
ET-5050H-3F1W	Neutral White	3,250	5,100		14.5lm

Note:

1. Luminous intensity is measured with an accuracy of  $\pm$  10%.

#### Forward Voltage Characteristics

#### The following table describes forward voltage of PLCC 5050 series

< Table 4 Forward voltage characteristics at I\_F=20mA and Ta=25  $^\circ\!\!\mathbb{C}$  for PLCC 5050 >

Part Name	Color		VF		Unit
		Min.	Тур.	Max.	onit
ET-5050H-3F1W	Neutral White	2.8		3.8	V

Note:

1. Forward Voltage is measured with an accuracy of  $\pm 0.1V$ 

#### Color Temperature Characteristics T<sub>J</sub>=25°C

< Table 5 Color Rendering Index Characteristics at T\_J=25  $^\circ\!\mathbb{C}$  for PLCC 5050 series >

Part Name	Color	CRI
	0000	Тур
ET-5050H-3F1W	Neutral White	75

#### Note:

1. CRI is measured with an accuracy of  $\pm 5$ 



#### **JEDEC Information**

JEDEC is used to determine what classification level should be used for initial reliability qualification. Once identified, the LEDs can be properly packaged, stored and handled to avoid subsequent thermal and mechanical damage during the assembly solder attachment and/or repair operation. The present moisture sensitivity standard contains six levels, the lower the level ,the longer the devices floor life. PLCC 5050 series are certified at level 2a. This means PLCC 5050 series have a floor life of 4 weeks before PLCC 5050 series need to re-baked.

	F	loor Life		Soak Re	quirements	
Lev	el Time	Condition	Standa		Accelerated	
		T	ime (hours)	Condition	Time (hours)	Condition
2a	a 4 weel	<s <br="" ≦30°c="">60% RH</s>	696 +5/-0	30℃ / 60% RH	120 +1/-0	60℃ /60% RH
	Flo	or Life	Soak Requirements			
Level	FIU		Sta	ndard	Accelera	ted Equivalent
	Time	Condition	Time(hours)	Conditio	n Time(hours	s) Condition
1	Unlimited	≦ <b>30°</b> C/ <b>85%</b> RH	168 +5/-0	85℃/85% F	RH	
2	1 year	≦30°C/60% RH	168 +5/-0	85℃/60% F	RH	
2a	4 weeks	≦ <b>30°</b> C/60% RH	696 <sup>1</sup> +5/-0	30°C/60% I	RH 120 +1/-0	60°C/60% RH
3	168 hours	≦30°C/60% RH	192 <sup>1</sup> +5/-0	30°C/60% F	RH 40 +5/-0	60°C/60% RH
4	72 hours	≦30°C/60% RH	96 <sup>1</sup> +5/-0	30°C/60% F	RH 20 +5/-0	60°C/60% RH
5	48 hours	≦ <b>30°</b> C/60% RH	72 <sup>1</sup> +5/-0	30°C/60% I	RH 15 +5/-0	60°C/60% RH
5a	24 hours	≦30°C/60% RH	48 <sup>1</sup> +5/-0	30°C/60% I	RH 10 +5/-0	60°C/60% RH
6	Time on tabel (TOL)	≦ <b>30°</b> C/60% RH	TOL	30°C/60% I	RH	

#### < Table 6 JEDEC characteristics for PLCC 5050 series >

Note:

1. The standard soak time includes a default value of 24 hours for semiconductor

manufacturer's exposure time (MET) between bake and bag, and includes maximum time allowed out of the bag at the distributor's facility.



#### **Reliability Items and Failure Measures**

#### **Reliability test**

# The following table describes operating life, mechanical, and environmental tests performed on PLCC 5050 series.

<Table 7 Operating life, mechanical, and environmental characteristics for PLCC 5050 series>

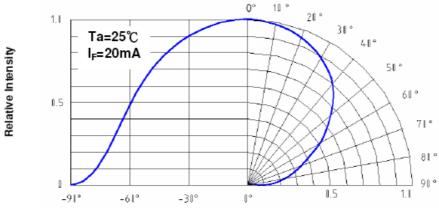
	Reliability Test 1		
Stress Test	Stress Conditions	Stress Duration	Failure Criteria
Temperature and Humidity	60℃ / 60%RH	120 hours	No catastrophics
IR Reflow	Peak temp.=255~260°C*3 times	3 times	No catastrophics
	Reliability Test 2		
Stress Test	Stress Conditions	Stress Duration	Failure Criteria
Room Temperature Operating Life	25°C , I <sub>F</sub> = max DC (Note 2)	1000 hours	No catastrophics
High Temperature and high Humidity Life	$85^\circ\!\mathrm{C}$ / $85\%RH,~I_F$ = 5 mA	1000 hours	No catastrophics
Low Temperature Storage	- <b>40</b> ℃	1000 hours	No catastrophics
High Temperature and high Humidity Storage	85℃ / 85%RH	1000 hours	No catastrophics
Ambient Temperature Life	$25^{\circ}$ C, I <sub>F</sub> = 20 mA	1000 hours	No catastrophics
Temperature Cycle	-40 $^\circ\!\mathrm{C}/100^\circ\!\mathrm{C}$ ,30 min dwell $~<15min$ transfer	200 cycles	No catastrophics
Thermal Shock	-40 / 100 $^\circ\!\mathrm{C}$ , 15 min dwell ${<}10$ sec transfer	200 cycles	No catastrophics

Notes:

- 1. Reliability test 2 is performed after reliability test 1
- 2. Depending on the maximum derating curve.
- 3. Failure Criteria:
  - Electrical failures V<sub>F</sub> Shift >=10% Luminous Intensity I<sub>V</sub> Decay>= 35%



#### **Color Spectrum and Radiation Pattern**



**Radiation Angle** 

<Figure 3 Beam pattern diagram for PLCC 5050 series >

< Table 8 Viewing angle for PLCC 5050 series >

Part Name	Color	<b>2⊝¹⁄₂(Typ.)</b> Lambertian	Unit
ET-5050H-3F1W	Neutral White	120	Deg.

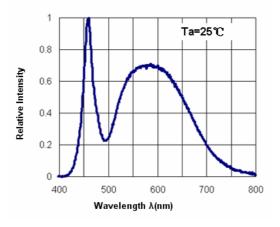
#### Color Temperature or Dominant Wavelength Characteristics at Ta=25°C

< Table 9 Dominant Wavelength or Peak wavelength or Color Temperature Characteristics at Ta=25 $^\circ\!C$  for PLCC 5050 series >

Part Name	Color	CCT Min.	Max.	Unit
ET-5050H-3F1W	Neutral White	3,800	5,000	К

Note:

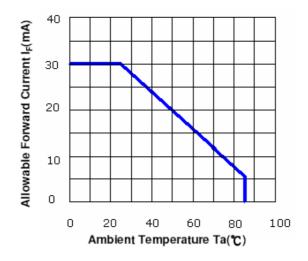
1. Color Temperature is measured with an accuracy of ± 200K



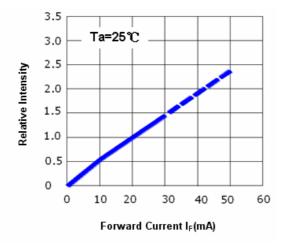
< Figure 4 Wavelength & relative intensity for PLCC 5050 series.>



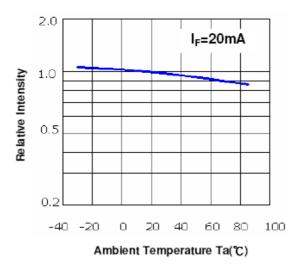
#### **Optical & Electrical Characteristics**



< Figure 5 Ambient temperature & forward current for PLCC 5050 series >

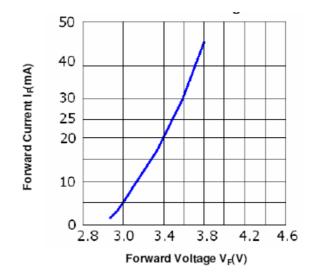


< Figure 6 Forward current & relative intensity for PLCC 5050 series >



< Figure 7 Ambient temperature & relative intensity for PLCC 5050 series >

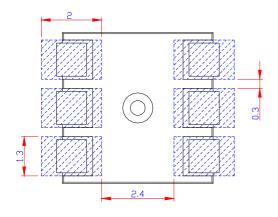




< Figure 8 Forward current & forward voltage for PLCC 5050 series >



# **Product Soldering Instructions**



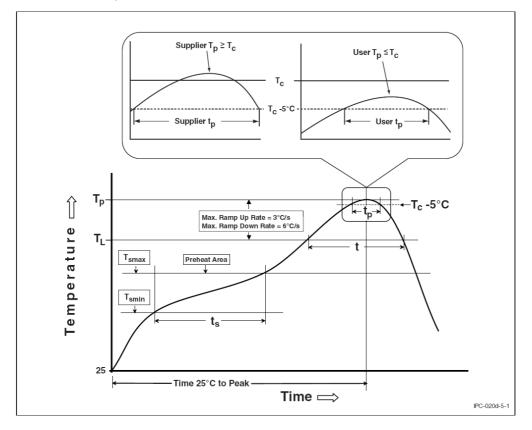
<Figure 9 Pad dimensions >

#### Note:

1. All dimensions are measured in mm.



The following reflow soldering profiles are provided for reference. It is recommended that users follow the recommended soldering profile provided by the manufacturer of the solder paste used



< Figure 10 Time-temperature of JEDEC J-STD-020D >

#### **Table of Classification Reflow Profiles**

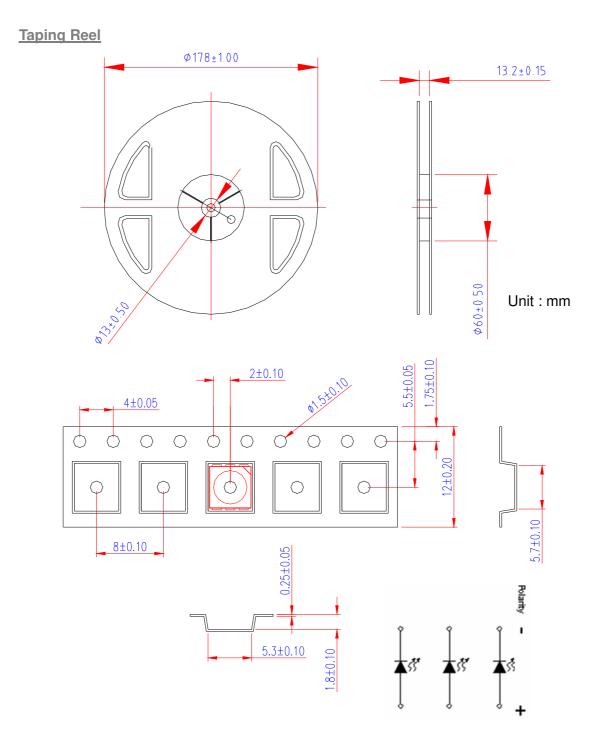
< Table 10 Reflow profiles >

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak Temperature min (Tsmin) Temperature max (Tsmax) Time (Tsmin to Tsmax) (ts)	100 ℃ 150 ℃ 60-120 seconds	150 ℃ 200 ℃ 60-120 seconds
Average ramp-up rate (Tsmax to Tp)	3 ℃/second max.	3 °C/second max.
Liquidous temperature (TL) Time at liquidous (tL)	183 ℃ 60-150 seconds	217 ℃ 60-150 seconds
Peak package body temperature (Tp)*	230 ℃ ~235 ℃ *	255 ℃ ~260 ℃ *
Classification temperature (Tc)	235 ℃	260 ℃
Time $(tp)^{**}$ within 5 °C of the specified classification temperature (Tc)	20** seconds	30** seconds
Average ramp-down rate (Tp to Tsmax)	6 °C/second max.	6 °C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

\*\* Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.



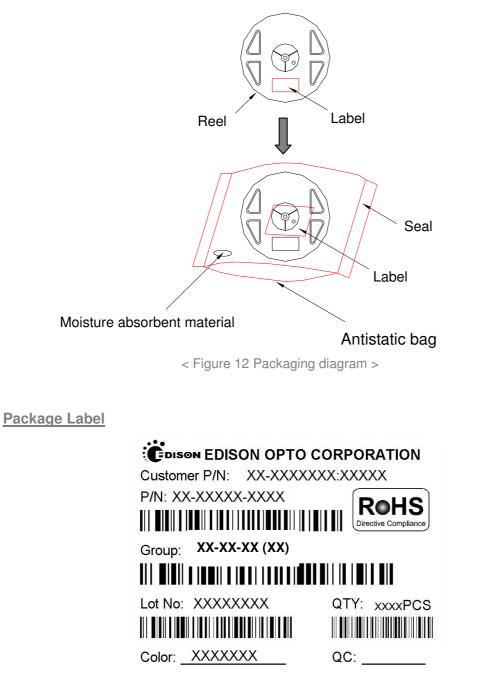
# **Product Packaging Information**



< Figure 11 Taping reel dimensions >



#### **Packaging**



< Figure 13 Package label >

< Table 11 Package dimensions and quantity >

Item	Quantity	Total	Dimensions(mm)
Reel	1,000pcs	1,000pcs	Diameter=178
Inner box	5 reels	5,000pcs	240*235*67
Outer box	10 inner boxes	50,000pcs	500*260*355mm



#### Precaution for Use

#### **Storage**

#### 1.1 Before opening the package

The LEDs should be kept at <40 $^{\circ}$ C & <90 $^{\circ}$ RH. The LEDs should be used within a year. When storing the LEDs, moisture proof package with absorbent material (silica gel) is recommended.

#### 1.2 After opening the package

The LEDs should be kept at  $\leq 30^{\circ}$ C &  $\leq 60\%$ RH. The LEDs should be soldered within 168 hours (7days) after opening the moisture proof package.

If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with moisture proof package within absorbent material (silica gel). It is also recommended to return the unused LEDs to the original moisture proof package and to seal the moisture proof package again.

If the moisture absorbent material (silica gel) vapors or expires the expiration date, baking treatment should be performed by using the following conditions:  $60^{\circ}$ C for 20 hours.

The LEDs electrode and leadframe comprise a silver plated copper alloy. The silver surface may be affected by environments. Please avoid conditions which may cause the LEDs being corroded or discolored. The corrosion or discoloration might lower solderability or affect optical characteristics.

Please avoid rapid transition in ambient temperature, especially in high humidity environments where condensation can occur.

#### Static electricity

The products are sensitive to static electricity and highly taken care when handling them.

Static electricity or surge voltage will damage the LEDs. It is recommended to wear an anti-electrostatic wristband or an anti-electrostatic glove when handling the LEDs.

All devices, equipments and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.



#### Note:

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## Forward Voltage Ranks

< Table 12 Forward voltage rank at Ta=25 $^\circ\!\!\mathbb{C}\!>$ 

Bin	Condition	Min	Мах	Unit
UJ	IF=20mA/chip	2.8	3.0	
UK		3.0	3.2	
UL		3.2	3.4	V
UM		3.4	3.6	
UN		3.6	3.8	

Note:

1. Forward voltage measurement allowance is  $\pm 0.1$  V.

#### **Luminous Intensity Ranks**

< Table 13 Luminous intensity rank at Ta=25 $^\circ\!\!\mathbb{C}\!>$	>
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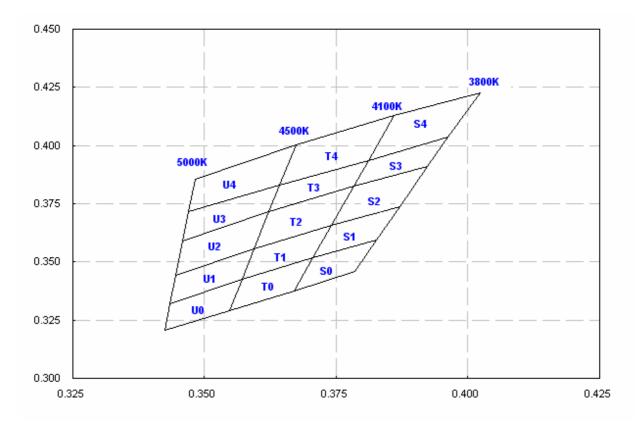
Bin	Condition	Min	Мах	Unit
ZL	20mA/chip	2,650	3,250	
ZM		3,250	3,950	
ZN		3,950	4,850	mcd
ZO		4,850	5,950	
ZP		5,950	7,250	

Note:

1. Luminous Intensity Measurement Allowance is ± 10%.



#### **CIE Chromaticity Diagram**



< Figure 14 PLCC 5050 series chromaticity diagram >



### Color Bin

Bin	Chromaticity Coordinate				
S0	Х	0.3825	0.3785	0.3670	0.3705
	Y	0.3529	0.3460	0.3377	0.3519
S1	Х	0.3470	0.3870	0.3825	0.3705
	Y	0.3658	0.3738	0.3595	0.3519
S2	Х	0.3782	0.3923	0.3870	0.3740
	Y	0.3824	0.3909	0.3738	0.3658
60	Х	0.3782	0.3811	0.3962	0.3923
S3	Y	0.3824	0.3937	0.4035	0.3909
S4	Х	0.3859	0.4022	0.3962	0.3811
	Y	0.4129	0.4227	0.4035	0.3937
ТО	Х	0.3705	0.3670	0.3548	0.3570
	Y	0.3519	0.3377	0.3290	0.3425
τ.	Х	0.3622	0.3782	0.3705	0.3740
T1	Y	0.3716	0.3824	0.3519	0.3658
T2	Х	0.3594	0.3824	0.3740	0.3594
12	Y	0.3556	0.3716	0.3658	0.3556
то	Х	0.3642	0.3811	0.3782	0.3622
Т3	Y	0.3828	0.3937	0.3824	0.3716
	Х	0.3672	0.3859	0.3811	0.3642
T4	Y	0.4002	0.4129	0.3937	0.3828
110	Х	0.3570	0.3548	0.3425	0.3433
UO	Y	0.3425	0.3290	0.3208	0.3320
114	Х	0.3444	0.3433	0.3570	0.3594
U1	Y	0.3442	0.3320	0.3425	0.3556
110	Х	0.3622	0.3594	0.3444	0.3457
U2	Y	0.3716	0.3556	0.3442	0.3591
110	Х	0.3642	0.3622	0.3457	0.3469
U3	Y	0.3828	0.3716	0.3591	0.3717
U4	Х	0.3642	0.3672	0.3481	0.3469
	Y	0.3828	0.4002	0.3856	0.3717

< Table 1 Color Bin S0-U4 at I\_F=20mA/chip ,Ta=25 $^\circ\!\!\! C$  for PLCC 5050 series >

Note:

1. Color coordinates measurement allowance is  $\pm 0.01$